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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 2835

Examiner: CHERVINSKY BORIS L

RECEIVED

In re PATENT APPLICATION of

Applicant : Jack Wang
Appln. No. : 10/717,447
Filed : 11/21/2003
Now Pat. No. : 7,019,979
Issued : 03/28/2006
For : Heat Dissipating Device Having
Improved Fastening Structure
Atty. Dkt. : OP-092000289

SEP 18 2009

OFFICE OF PETITIONS

REQUEST FOR PAYING
MAINTENANCE FEE
IN LARGE ENTITY

September 8, 2009

Assistant Commissioner for Patents
Washington, D.C. 20231

ATTENTION: ACCOUNTING DIVISION OFFICE OF FINANCE

Sir:

The Patent Maintenance Fee due at 3.5 years for the above-identified application was timely paid on 08/04/2009. Applicant notices the paid maintenance fee \$490 was for small entity. However, Applicant was no long a small entity at paying issue and publication fees on 02/03/2005 (please see attached). Therefore, please help to change the Applicant to a large entity and deduct \$490 from the Deposit Account No. 502751.

Respectfully submitted.

By /Jimmy Shih/
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09/14/2009 HANGURA 00000109 502751 7019979
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